

Final datasheet

High speed and low saturation voltage 750 V TRENCHSTOP™ IGBT7 technology co-packed with soft and fast recovery Emitter Controlled 7 diode

Features

- $V_{CE} = 750\text{ V}$
- $I_C = 150\text{ A}$
- Low switching losses
- Very low collector-emitter saturation voltage V_{CEsat}
- Very soft, fast recovery antiparallel diode
- Smooth switching behavior
- Humidity robustness
- Optimized for hard switching, two- and three-level topologies
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

- Industrial UPS
- EV Charging
- String inverter
- Energy storage systems (ESS)

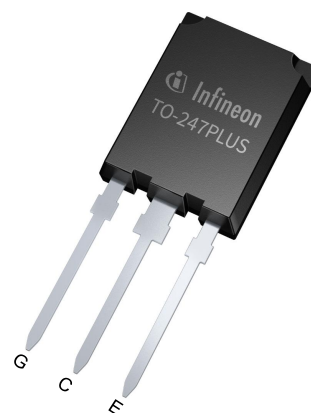
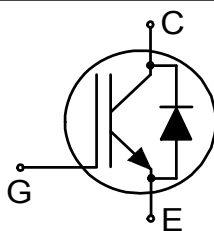
Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description

Package pin definition:

- Pin G – Gate
- Pin C & backside– Collector
- Pin E – Emitter



Type	Package	Marking
IKQ150N75EH7	PG-TO247-3-U01	K150GEH7



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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.19	0.24	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.26	0.33	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		750	V
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25\text{ °C}$	160	A
			$T_c = 100\text{ °C}$	160	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			600	A
Turn-off safe operating area		$V_{CE} \leq 750\text{ V}$, $t_p \leq 1\text{ }\mu\text{s}$, $T_{vj} \leq 175\text{ °C}$		600	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}$, $D < 0.01$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	625	W
			$T_c = 100\text{ °C}$	313	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 150\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		1.45	1.75	V
			$T_{vj} = 175\text{ °C}$		1.75		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Gate-emitter threshold voltage	V_{GEth}	$I_C = 1.32 \text{ mA}$, $V_{CE} = V_{GE}$	3.2	4	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 750 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		50	μA
			$T_{vj} = 175 \text{ °C}$	4500		
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = 20 \text{ V}$			100	nA
Transconductance	g_{fs}	$I_C = 150 \text{ A}$, $V_{CE} = 20 \text{ V}$		180		S
Input capacitance	C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		7950		pF
Output capacitance	C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		222		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		30		pF
Gate charge	Q_G	$V_{CC} = 600 \text{ V}$, $I_C = 150 \text{ A}$, $V_{GE} = 15 \text{ V}$		300		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	45		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	42		
Rise time (inductive load)	t_r	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	49		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	50		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	304		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	342		
Fall time (inductive load)	t_f	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	59		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	56		
Turn-on energy	E_{on}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	5.2		mJ
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	6.3		
Turn-off energy	E_{off}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 10 \text{ }\Omega$, $R_{G(off)} = 10 \text{ }\Omega$	$T_{vj} = 25 \text{ °C}$, $I_C = 150 \text{ A}$	3.5		mJ
			$T_{vj} = 175 \text{ °C}$, $I_C = 150 \text{ A}$	4.3		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\ \Omega$, $R_{G(off)} = 10\ \Omega$		8.7		mJ
				10.7		
Operating junction temperature	T_{vj}		-40		175	°C

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	$T_c = 25\text{ °C}$	A
			$T_c = 100\text{ °C}$	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		600	A
Power dissipation	P_{tot}	$T_c = 25\text{ °C}$	455	W
		$T_c = 100\text{ °C}$	227	

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 150\text{ A}$		$T_{vj} = 25\text{ °C}$	1.65	V
				$T_{vj} = 175\text{ °C}$	1.6	
Diode reverse recovery time	t_{rr}	$V_R = 400\text{ V}$, $R_{G(on)} = 10\ \Omega$		$T_{vj} = 25\text{ °C}$, $I_F = 150\text{ A}$	113	ns
				$T_{vj} = 175\text{ °C}$, $I_F = 150\text{ A}$	174	
Diode reverse recovery charge	Q_{rr}	$V_R = 400\text{ V}$, $R_{G(on)} = 10\ \Omega$		$T_{vj} = 25\text{ °C}$, $I_F = 150\text{ A}$	3.7	μC
				$T_{vj} = 175\text{ °C}$, $I_F = 150\text{ A}$	8.8	
Diode peak reverse recovery current	I_{rrm}	$V_R = 400\text{ V}$, $R_{G(on)} = 10\ \Omega$		$T_{vj} = 25\text{ °C}$, $I_F = 150\text{ A}$	54.8	A
				$T_{vj} = 175\text{ °C}$, $I_F = 150\text{ A}$	84.2	

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400 \text{ V}, R_{G(on)} = 10 \text{ } \Omega$	$T_{vj} = 25 \text{ } ^\circ\text{C}, I_F = 150 \text{ A}$		-795		A/ μs
			$T_{vj} = 175 \text{ } ^\circ\text{C}, I_F = 150 \text{ A}$		-785		
Reverse recovery energy	E_{rec}	$V_R = 400 \text{ V}, R_{G(on)} = 10 \text{ } \Omega$	$T_{vj} = 25 \text{ } ^\circ\text{C}, I_F = 150 \text{ A}$		0.7		mJ
			$T_{vj} = 175 \text{ } ^\circ\text{C}, I_F = 150 \text{ A}$		2.12		
Operating junction temperature	T_{vj}			-40		175	$^\circ\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Electrical Characteristic, at $T_{vj} = 25^\circ\text{C}$, unless otherwise specified.

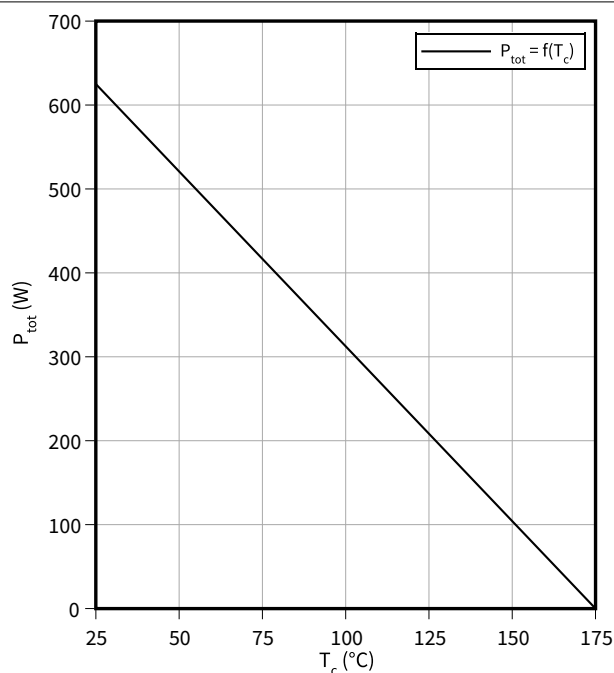
Dynamic test circuit, parasitic inductance $L_\sigma = 8 \text{ nH}$, parasitic capacitor $C_\sigma = 30 \text{ pF}$ from Fig. E. Energy losses include "tail" and diode reverse recovery.

4 Characteristics diagrams

Power dissipation as a function of case temperature

$$P_{\text{tot}} = f(T_c)$$

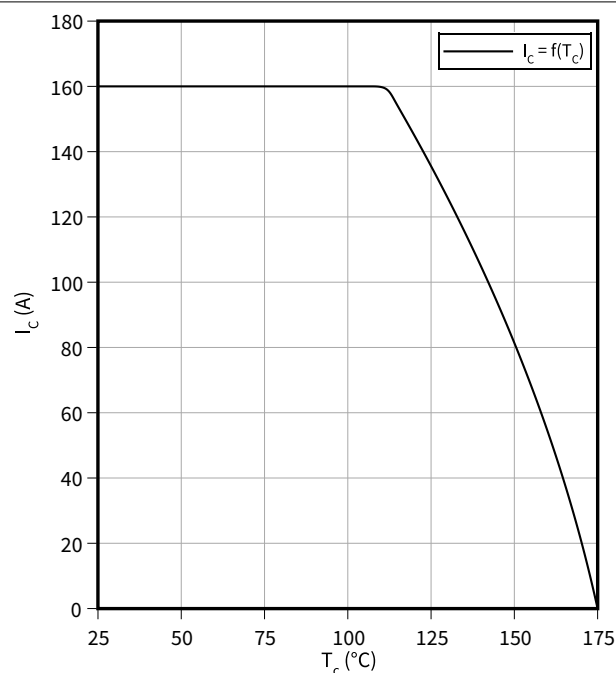
$$T_{vj} \leq 175^\circ\text{C}$$



Collector current as a function of case temperature

$$I_C = f(T_c)$$

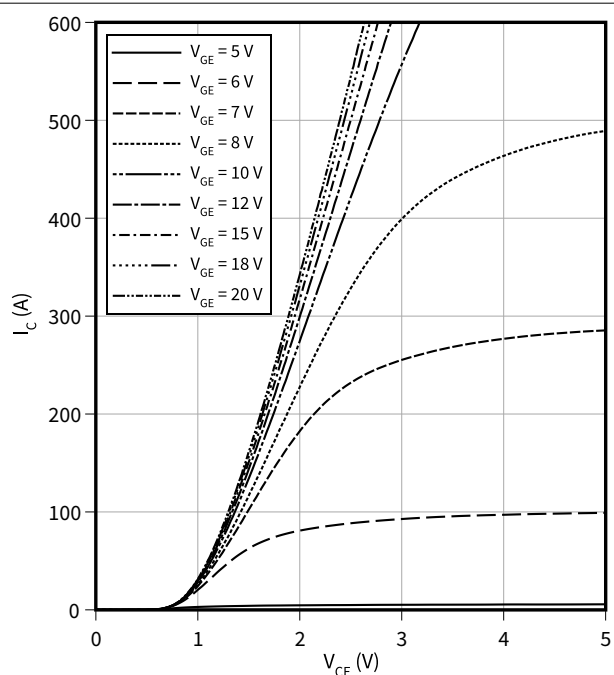
$$T_{vj} \leq 175^\circ\text{C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

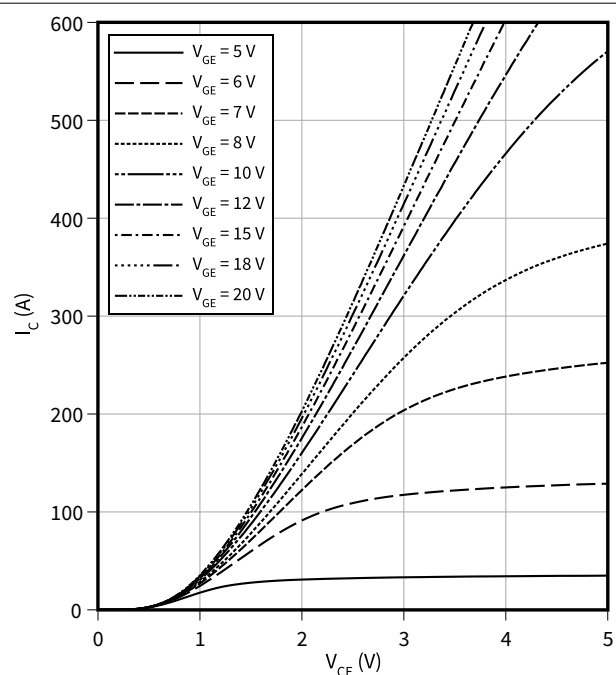
$$T_{vj} = 25^\circ\text{C}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

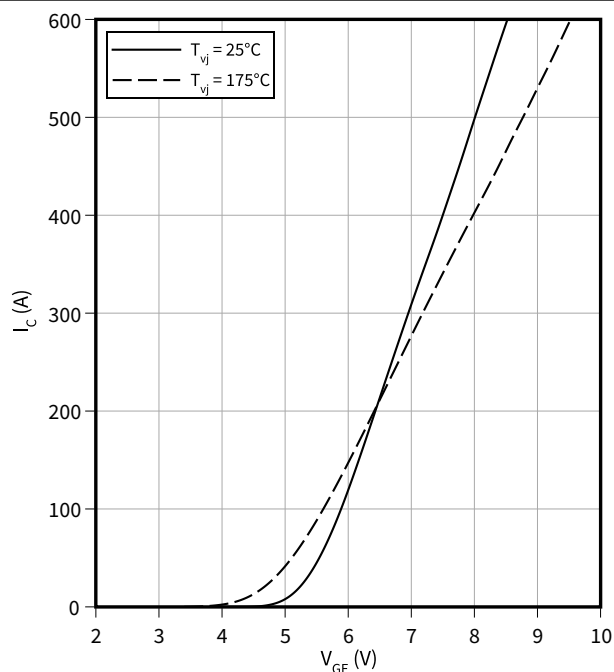
$$T_{vj} = 175^\circ\text{C}$$



4 Characteristics diagrams
Typical transfer characteristic

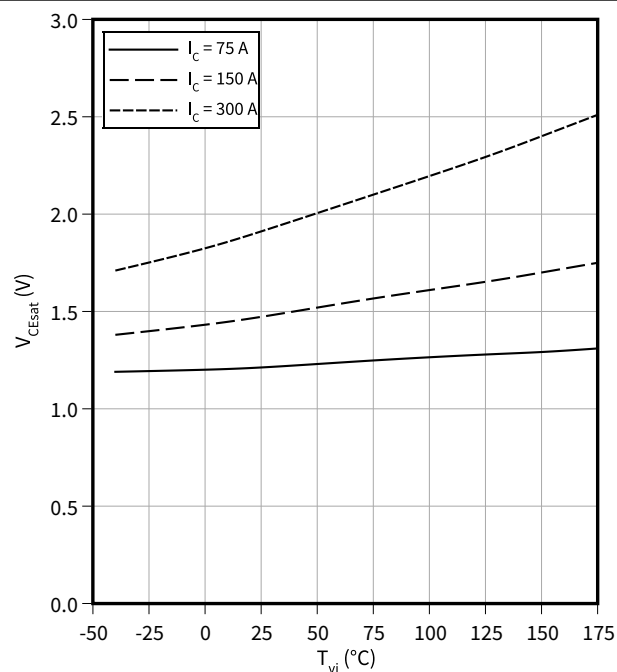
$$I_C = f(V_{GE})$$

$$V_{CE} = 20 \text{ V}$$


Typical collector-emitter saturation voltage as a function of junction temperature

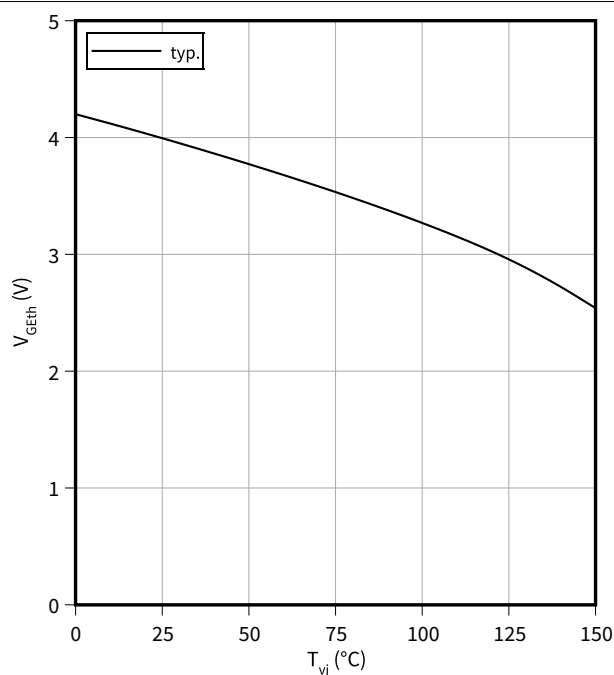
$$V_{CEsat} = f(T_{vj})$$

$$V_{GE} = 15 \text{ V}$$


Gate-emitter threshold voltage as a function of junction temperature

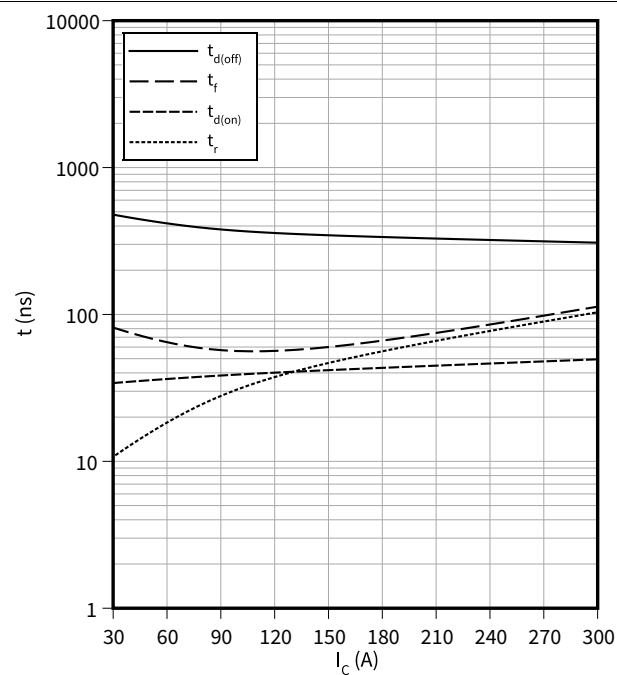
$$V_{GEth} = f(T_{vj})$$

$$I_C = 1.32 \text{ mA}$$


Typical switching times as a function of collector current

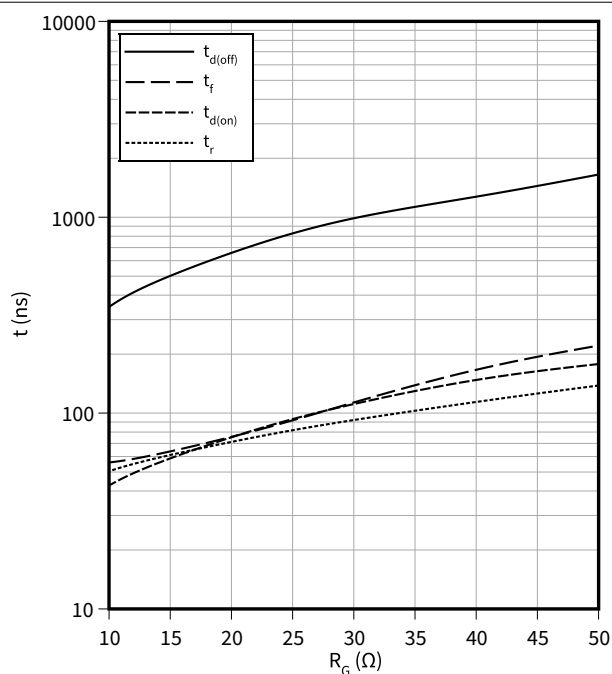
$$t = f(I_C)$$

$$V_{CC} = 400 \text{ V}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$$

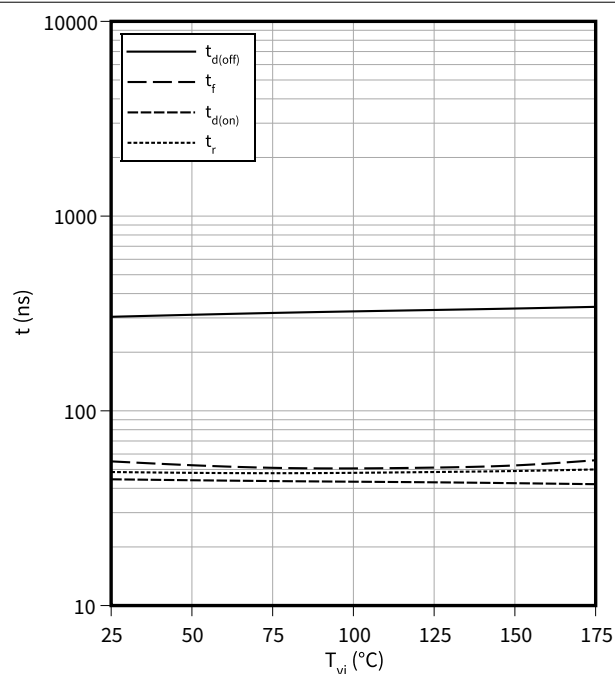


4 Characteristics diagrams
Typical switching times as a function of gate resistor

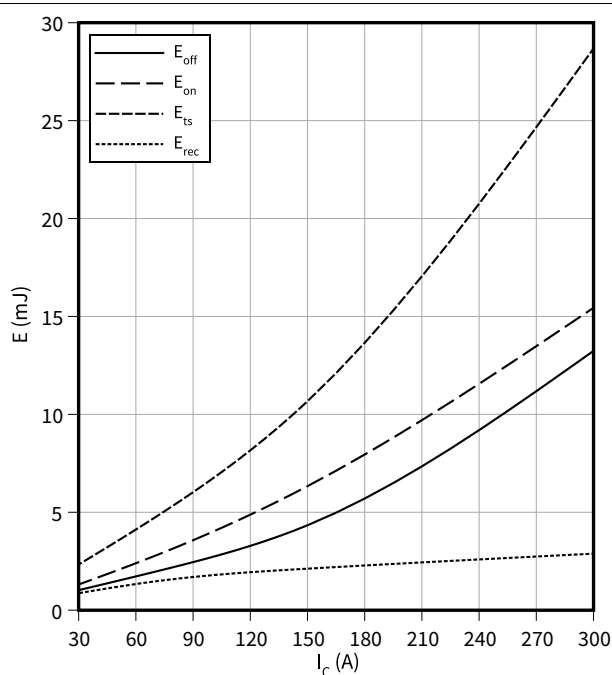
$$t = f(R_G)$$

 $I_C = 150 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}$

Typical switching times as a function of junction temperature

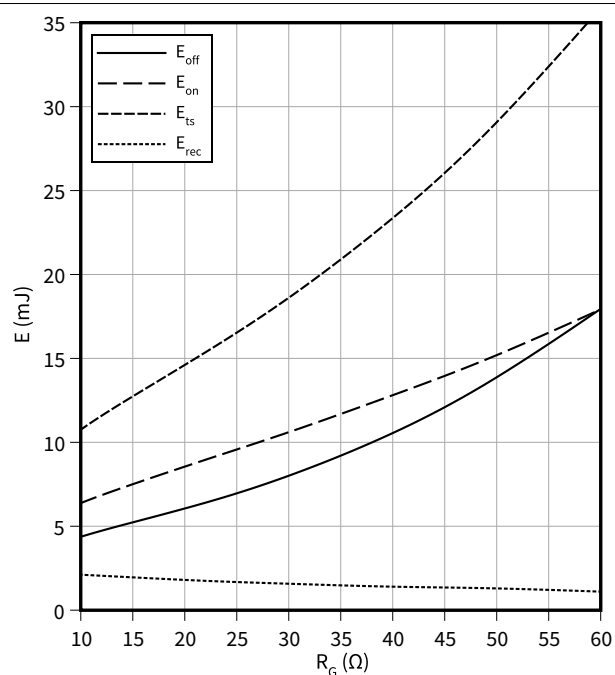
$$t = f(T_{vj})$$

 $I_C = 150 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 10 \text{ } \Omega$

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$

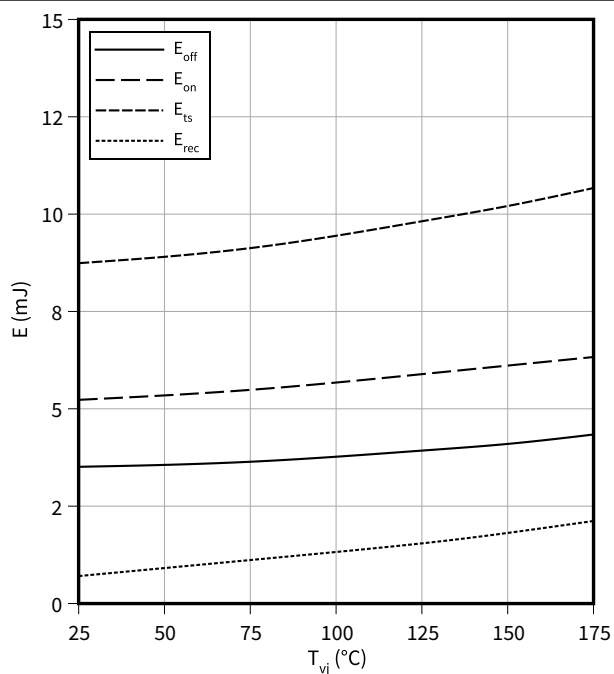
 $V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \text{ } \Omega$

Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

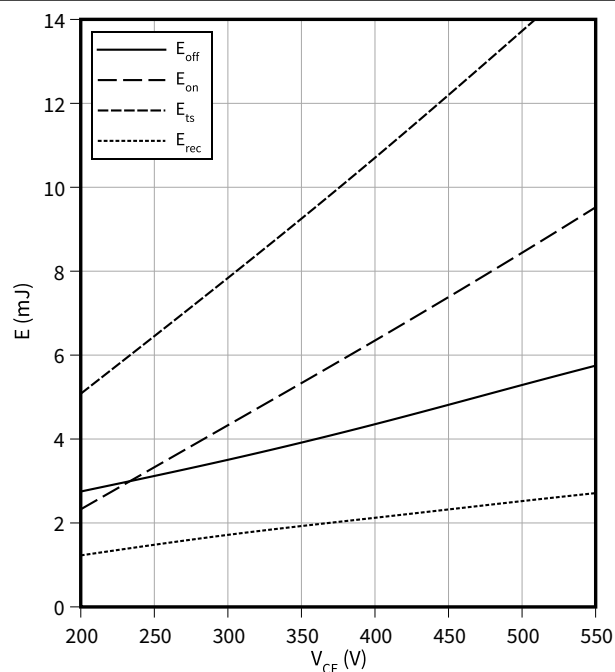
 $I_C = 150 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}$


4 Characteristics diagrams
Typical switching energy losses as a function of junction temperature

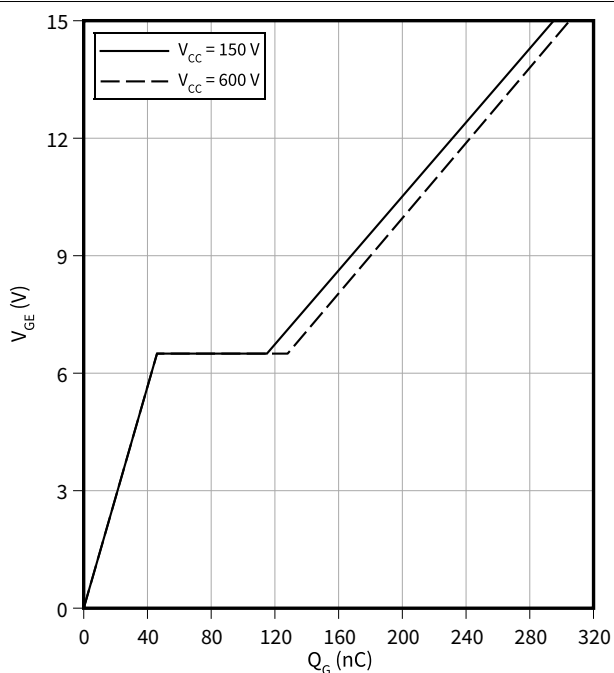
$$E = f(T_{vj})$$

 $I_C = 150 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$

Typical switching energy losses as a function of collector emitter voltage

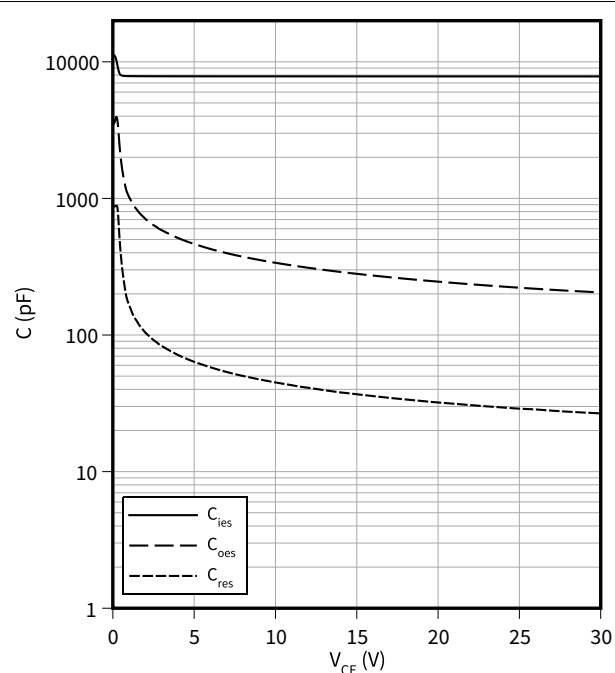
$$E = f(V_{CE})$$

 $I_C = 150 \text{ A}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$

Typical gate charge

$$V_{GE} = f(Q_G)$$

 $I_C = 150 \text{ A}$

Typical capacitance as a function of collector-emitter voltage

$$C = f(V_{CE})$$

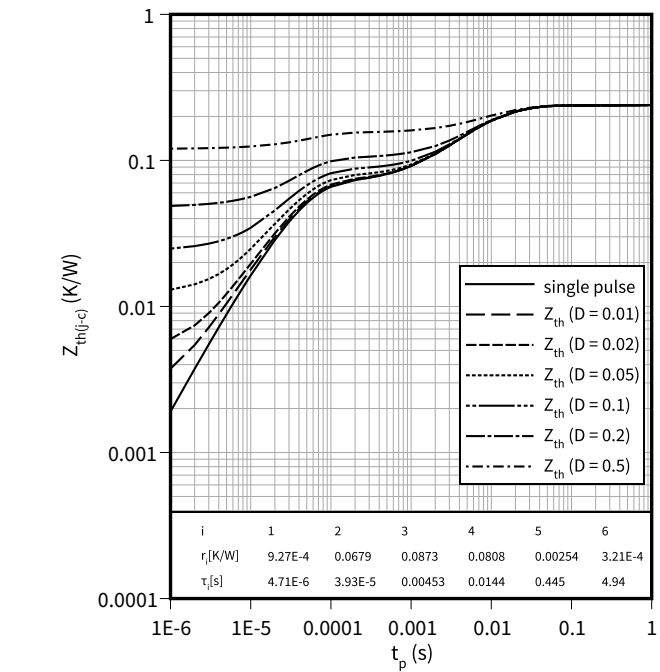
 $f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$


4 Characteristics diagrams

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-c)} = f(t_p)$$

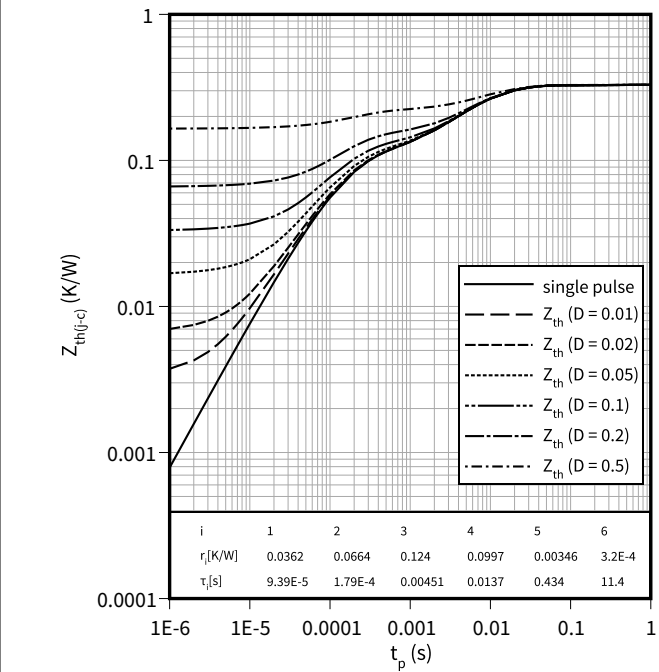
$$D = t_p/T$$



Diode transient thermal impedance as a function of pulse width

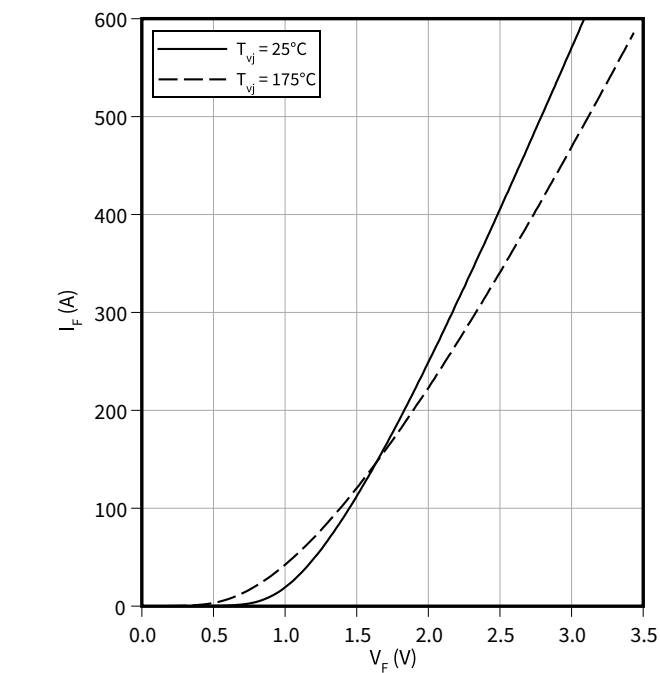
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



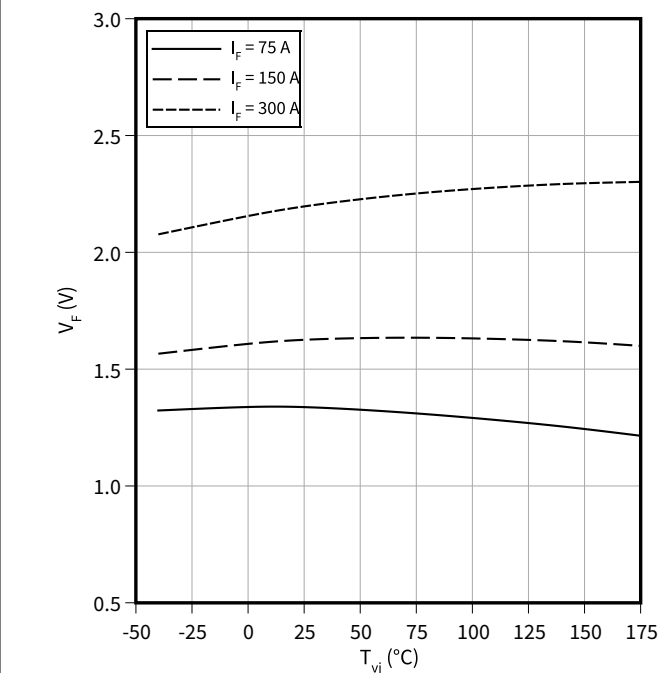
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



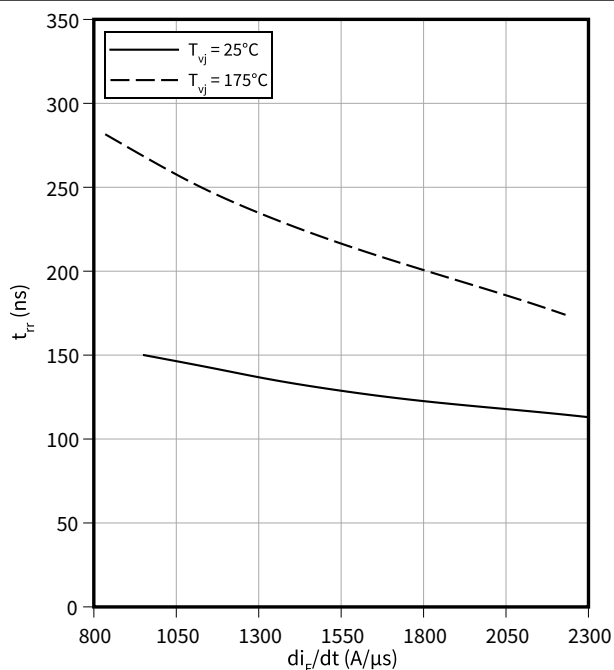
Typical diode forward voltage as a function of junction temperature

$$V_F = f(T_{vj})$$

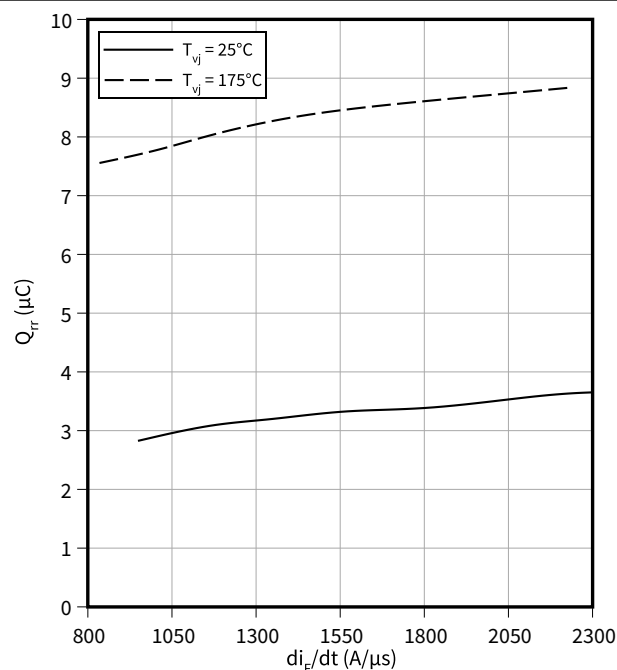


4 Characteristics diagrams
Typical reverse recovery time as a function of diode current slope

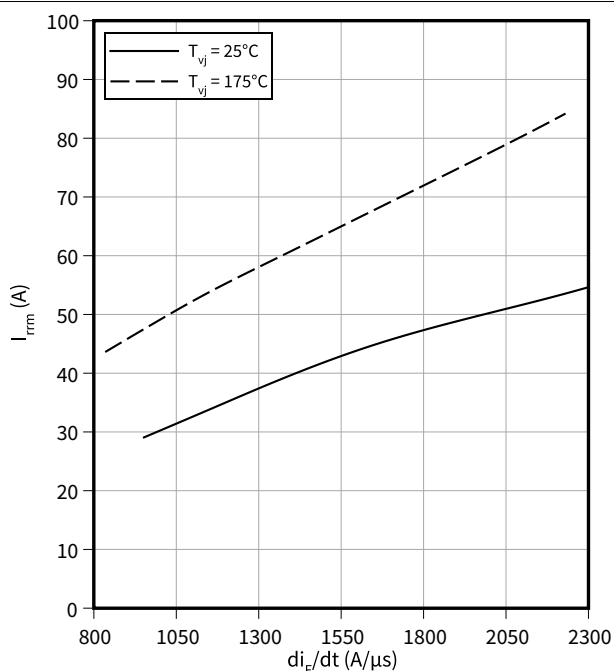
$$t_{rr} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 150 \text{ A}$

Typical reverse recovery charge as a function of diode current slope

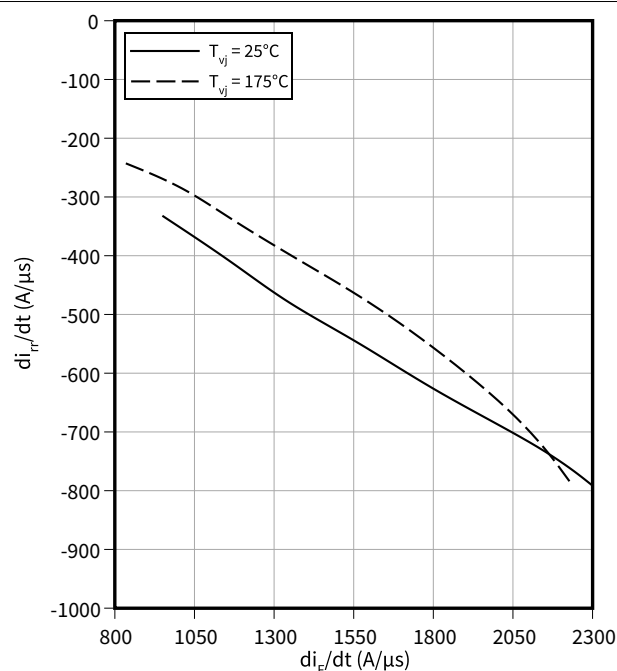
$$Q_{rr} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 150 \text{ A}$

Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 150 \text{ A}$

Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

$$di_{rr}/dt = f(di_F/dt)$$

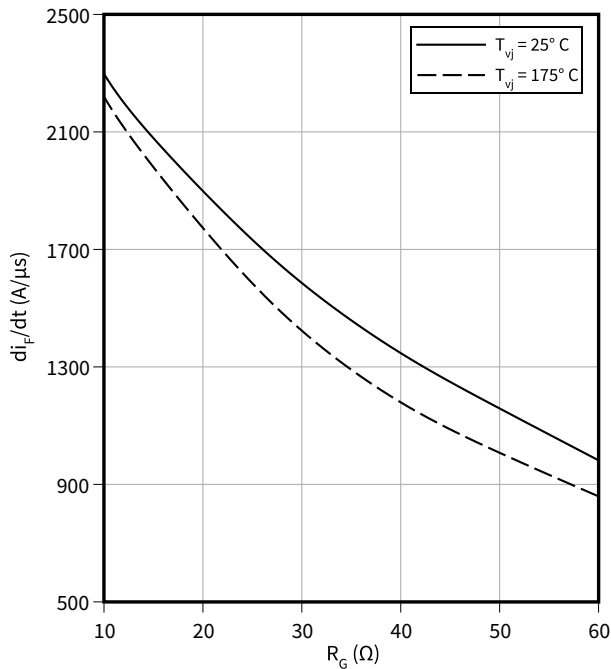
 $V_R = 400 \text{ V}, I_F = 150 \text{ A}$


4 Characteristics diagrams

Typical diode current slope as a function of gate resistor

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}$, $I_F = 150\text{ A}$



5 Package outlines

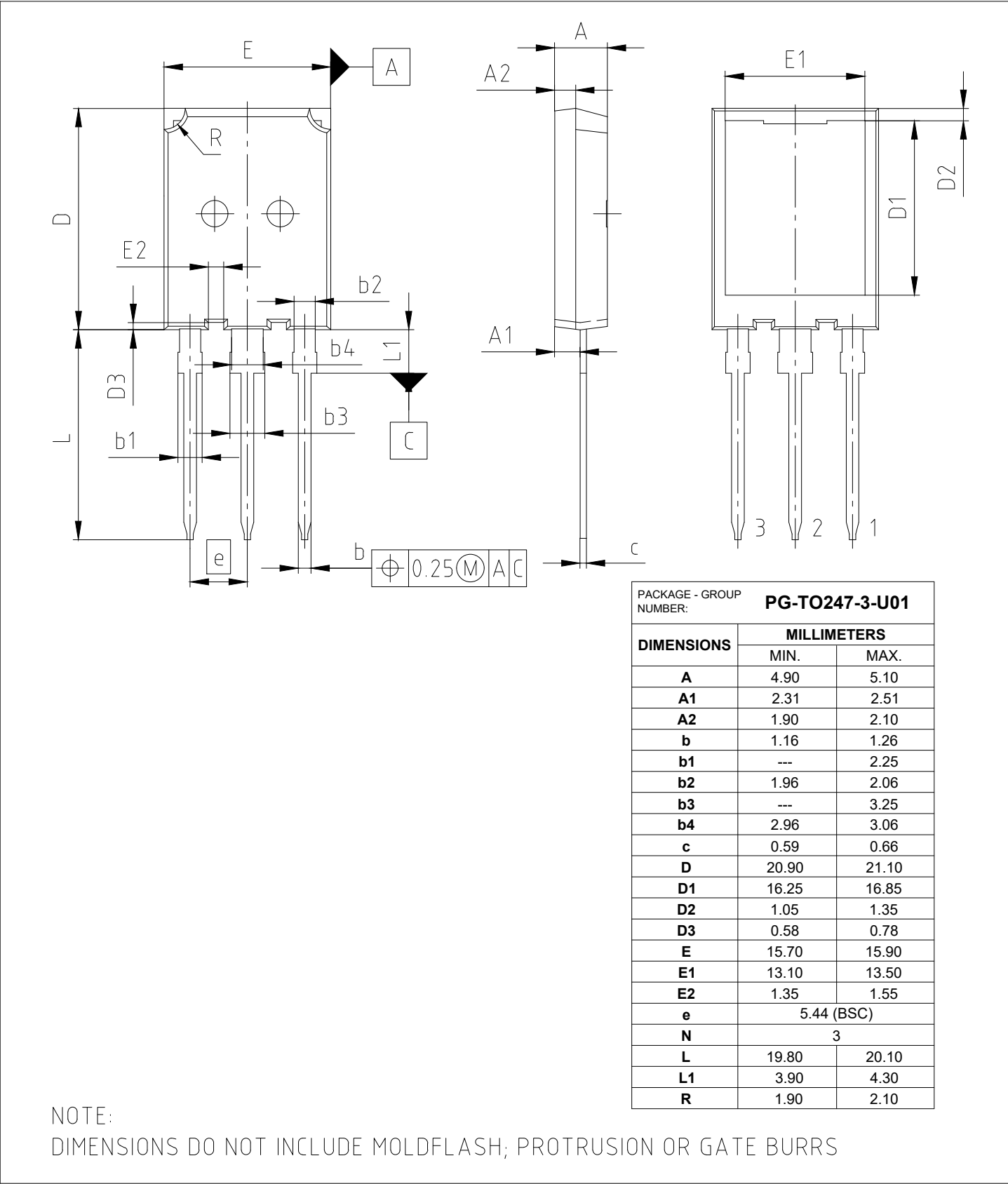


Figure 1

6 Testing conditions

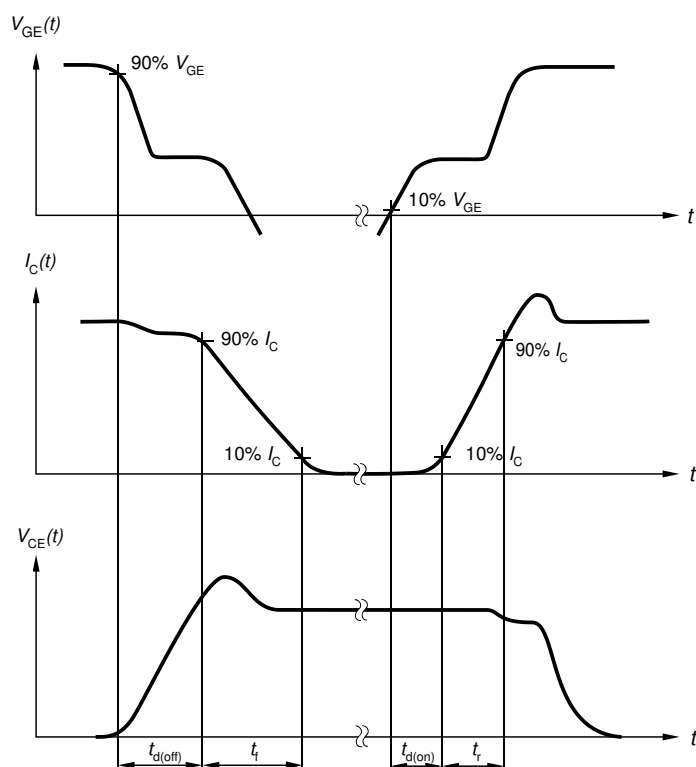


Figure A. Definition of switching times

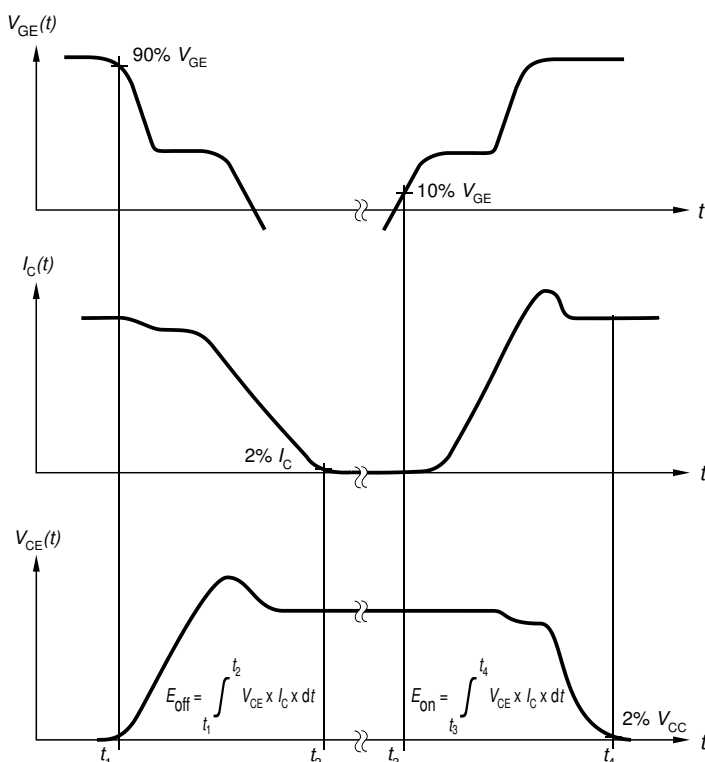


Figure B. Definition of switching losses

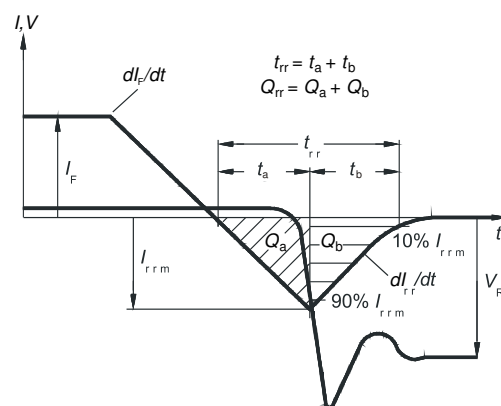


Figure C. Definition of diode switching characteristics

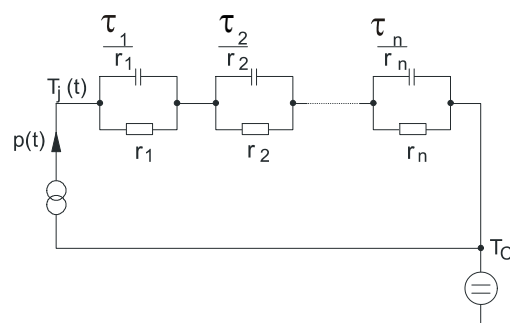


Figure D. Thermal equivalent circuit

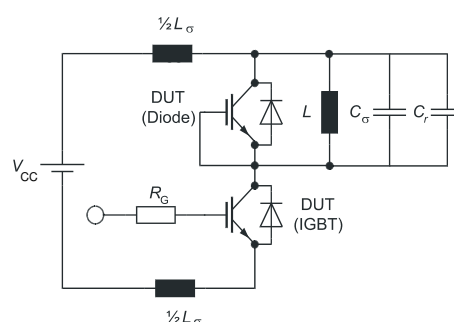


Figure E. Dynamic test circuit
Parasitic inductance L_{σ} ,
parasitic capacitor C_{σ} ,
relief capacitor C_r ,
(only for ZVT switching)

Revision history

Document revision	Date of release	Description of changes
0.10	2025-03-20	Preliminary datasheet
0.20	2025-05-30	Corrected "Typical Gate Charge" diagram
1.00	2025-07-31	Final datasheet

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